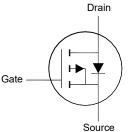
P-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified
- Low RDS(ON)
- Surface-mounted package
- Halogen and Antimony Free(HAF), RoHS compliant





1.Source 2.Source 3.Source 4.Gate 5.Drain 6.Drain 7.Drain 8.Drain DFN5060 Plastic Package

Key Parameters

Parameter	Value	Unit		
-BV _{DSS}	40	V		
Rds(ON) Max	15 @ -V _{GS} = 10 V			
	18 @ -V _{GS} = 4.5 V	mΩ		
-V _{GS(th)} typ	1.5	V		
Q _g typ	59 @ -V _{GS} = 10 V	nC		

Absolute Maximum Ratings (at Ta = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	-V _{DS}	40	V
Gate-Source Voltage	V _{GS}	± 20	V
Drain Current $T_c = 25^{\circ}C$ $T_c = 100^{\circ}C$		40 25	A
Peak Drain Current ¹⁾	-I _{DM}	160	А
Avalanche Current	-I _{AS}	32	А
Avalanche Energy ²⁾	Eas	51	mJ
Power Dissipation T _c = 25°C	PD	35.7	W
Operating Junction and Storage Temperature Range	TJ,Tstg	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	Rejc	3.5	°C/W
Thermal Resistance from Junction to Ambient ³⁾	Reja	55	°C/W

¹⁾ Pulse Test: Pulse Width \leq 100 µs, Duty Cycle \leq 2%, Repetitive rating, pulse width limited by junction temperature T_{J(MAX)} = 150°C. ²⁾ Limited by T_{J(MAX)}, starting T_J = 25 °C, L = 0.1 mH, R_g = 25 Ω , -I_{AS} = 32 A, -V_{GS} = 10 V.

³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



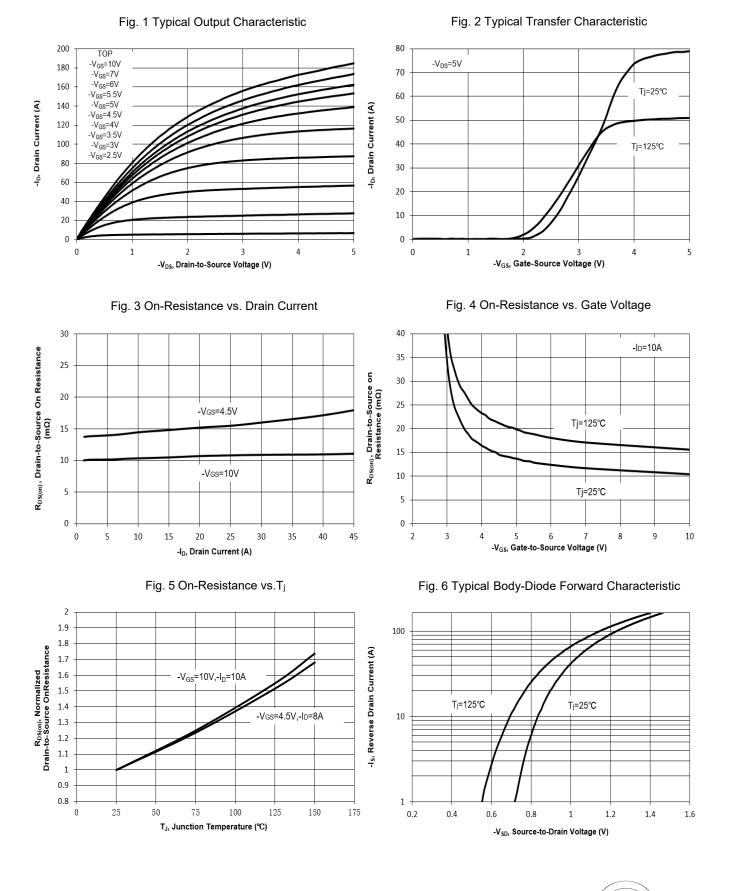
WTM504P150LS-AH

Characteristics at Ta = 25°C unless otherwise specified

Characteristics at T _a = 25°C unless otherwise specified Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS	- ,				
Drain-Source Breakdown Voltage at -I _D = 250 μA	-V(BR)DSS	40	-	-	V
Drain-Source On-State Current at -V _{DS} = 32 V	-IDSS	-	-	1	μA
Gate-Source Leakage Current at V _{GS} = ± 20 V	lgss	-	-	± 100	nA
Gate-Source Threshold Voltage at V _{DS} = V _{GS} , -I _D = 250 μA	-V _{GS(th)}	1	-	2.5	V
Drain-Source On-State Resistance at $-V_{GS} = 10 \text{ V}, -I_D = 10 \text{ A}$ at $-V_{GS} = 4.5 \text{ V}, -I_D = 8 \text{ A}$	Rds(on)	-	12 -	15 18	mΩ
DYNAMIC PARAMETERS					
Forward Transconductance at $-V_{DS} = 5 V$, $-I_D = 10 A$	g fs	-	32.4	-	S
Gate resistance at V _{DS} = 0 V, f = 1 MHz	Rg	-	2.2	-	Ω
Input Capacitance at V_{GS} = 0 V, -V _{DS} = 20 V, f = 1 MHz	Ciss	-	3538	-	pF
Output Capacitance at V_{GS} = 0 V, -V _{DS} = 20 V, f = 1 MHz	Coss	-	265	-	pF
Reverse Transfer Capacitance at V_{GS} = 0 V, -V _{DS} = 20 V, f = 1 MHz	Crss	-	178	-	pF
Total Gate Charge at -V _{GS} = 10 V, -V _{DS} = 20 V, -I _D = 10 A at -V _{GS} = 4.5 V, -V _{DS} = 20 V, -I _D = 10 A	Qg	-	59 28	-	nC
Gate-Source Charge at -V _{GS} = 10 V, -V _{DS} = 20 V, -I _D = 10 A	Qgs	-	10	-	nC
Gate-Drain Charge at -V _{GS} = 10 V, -V _{DS} = 20 V, -I _D = 10 A	Q_{gd}	-	9	-	nC
Turn-On Delay Time at -V _{GS} = 10 V, -V _{DD} = 20 V, -I _D = 10 A, R _g = 3.3 Ω	t _{d(on)}	-	19	-	ns
Turn-On Rise Time at -V _{GS} = 10 V, -V _{DD} = 20 V, -I _D = 10 A, R _g = 3.3 Ω	tr	-	25	-	ns
Turn-Off Delay Time at -V _{GS} = 10 V, -V _{DD} = 20 V, -I _D = 10 A, R _g = 3.3 Ω	$t_{d(off)}$	-	26	-	ns
Turn-Off Fall Time at -V _{GS} = 10 V, -V _{DD} = 20 V, -I _D = 10 A, R _g = 3.3 Ω	t _f	-	4	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at -I _S = 1 A, V _{GS} = 0 V	-Vsd	-	-	1.3	V
Body-Diode Continuous Current	-ls	-	-	40	А
Body-Diode Continuous Current, Pulsed	-I _{SM}	-	-	160	А
Body Diode Reverse Recovery Time at -I _s = 10 A, di/dt = 100 A / μs	t _{rr}	-	16.5	-	ns
Body Diode Reverse Recovery Charge at -I _S = 10 A, di/dt = 100 A / µs	Qrr	-	10.3	-	nC



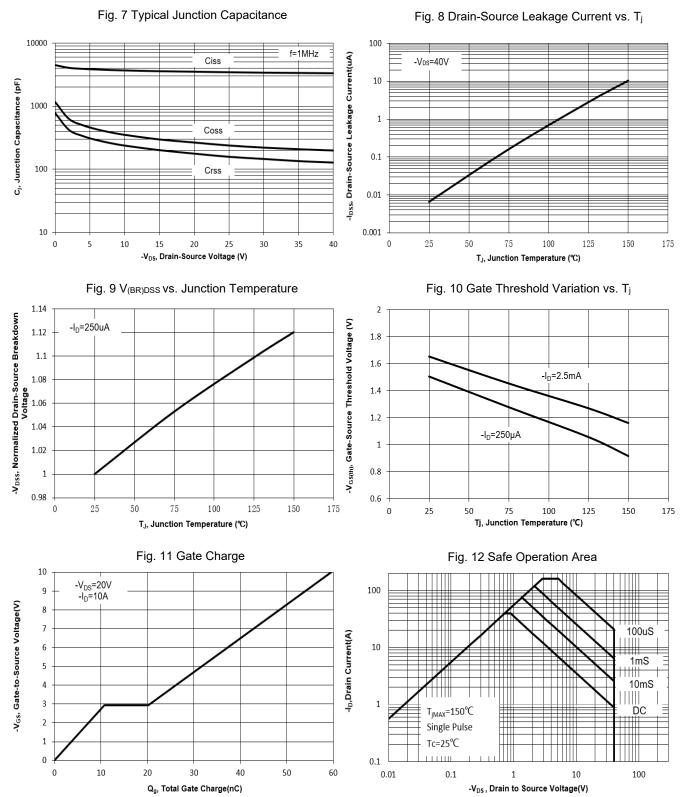
Electrical Characteristics Curves



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Electrical Characteristics Curves





Electrical Characteristics Curves

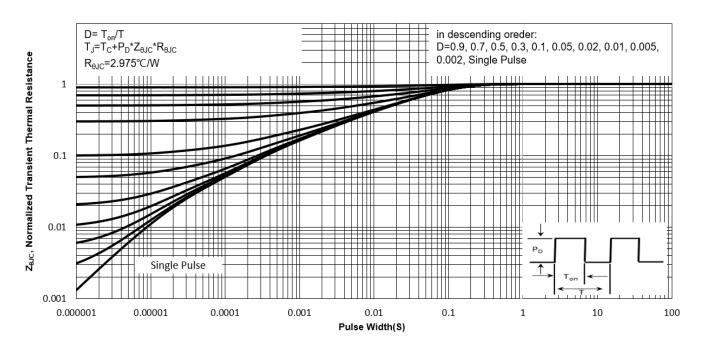
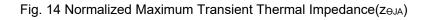
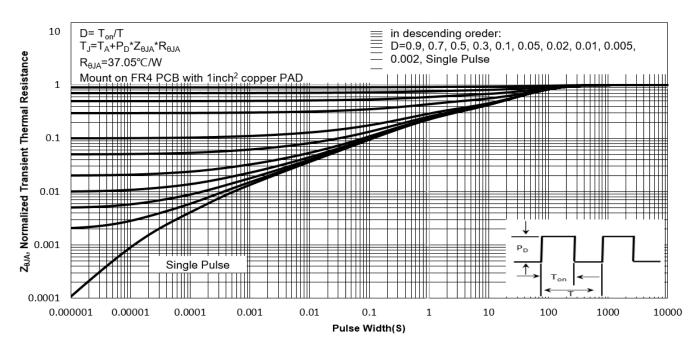


Fig. 13 Normalized Maximum Transient Thermal Impedance(zeuc)

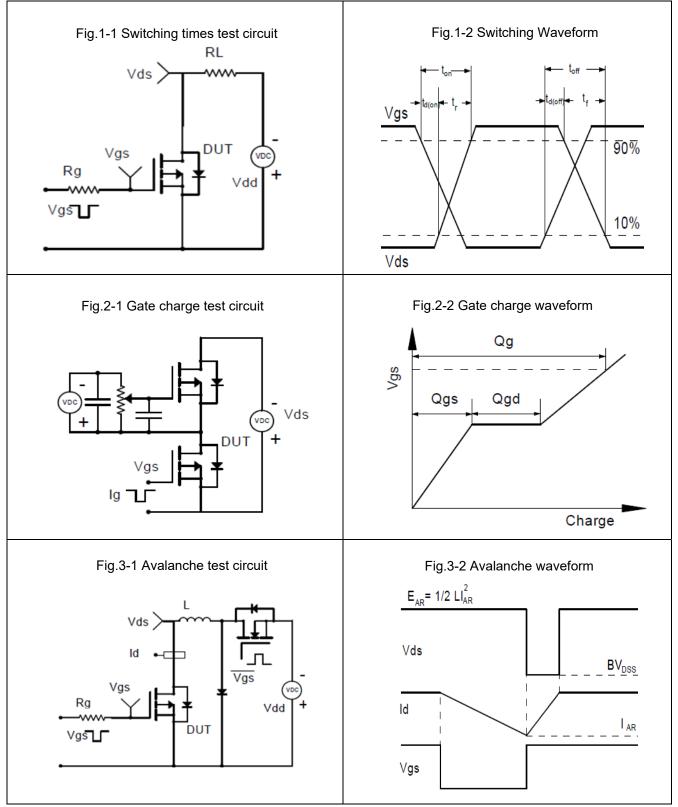






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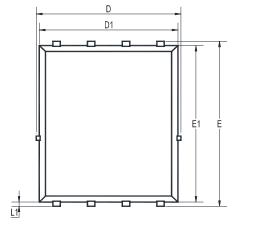
Test Circuits

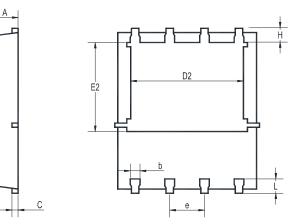




Package Outline Dimensions (Units: mm)

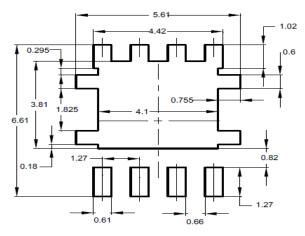
DFN5060





UNIT	А	b	С	D	D1	D2	E	E1	E2	е	L	L1	Н
	1.12	0.51	0.34	5.26	5.1	4.5	6.25	6	3.66	1.37	0.71	0.2	0.71
mm	0.9	0.33	0.11	4.7	4.7	3.56	5.75	5.6	3.18	1.17	0.35	0.06	0.35

Recommended Soldering Footprint

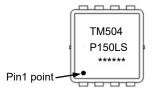


Packing information

Package Tape Width		Pit	ch	Reel	Size	Por Pool Poolking Quantity
Гаскауе	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity
DFN5060	12	8 ± 0.1	0.315 ± 0.004	330	13	5,000

Marking information

- " TM504P150LS " = Part No.
- " ****** " = Date Code Marking Font type: Arial





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